



N- and P-Channel 30-V (D-S) MOSFET

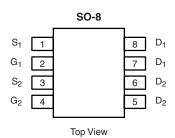
PRODUCT SUMMARY						
	V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)			
N-Channel	30	0.036 at V _{GS} = 10 V	5.9			
		0.053 at V _{GS} = 4.5 V	4.9			
P-Channel	- 30	0.053 at V _{GS} = - 10 V	- 4.9			
	- 30	0.090 at V _{GS} = - 4.5 V	- 3.7			

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFETs
- Compliant to RoHS Directive 2002/95/EC

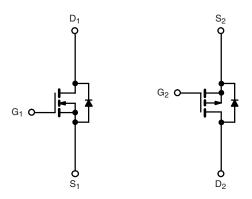






Ordering Information: Si4539ADY-T1-E3 (Lead (Pb)-free)

Si4539ADY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted								
Parameter			N-Chan		P-(Channel		
		Symbol	10 s	Steady State	10 s	Steady State	Unit	
Drain-Source Voltage		V_{DS}	30		- 30		V	
Gate-Source Voltage		V_{GS}	± 20		± 20		V	
Continuous Drain Current (T _{.I} = 150 °C) ^a	T _A = 25 °C	- I _D	5.9	4.4	- 4.9	- 3.7	_	
Continuous Diain Current (1) = 150 °C)	T _A = 70 °C		4.7	3.6	- 3.9	- 2.9		
Pulsed Drain Current		I _{DM}	30				Α	
Continuous Source Current (Diode Conduction) ^a		I _S	1.7	0.9	- 1.7	- 0.9		
M	T _A = 25 °C	P _D	2.0	1.1	2	1.1	W	
Maximum Power Dissipation ^a	T _A = 70 °C	' D	1.3	0.7	1.3	0.7	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150				°C	

THERMAL RESISTANCE RATINGS								
			N-Ch	annel	P-Channel			
Parameter		Symbol	Тур.	Max.	Тур.	Max.	Unit	
Maximum Junction-to-Ambient ^a	t ≤ 10 s	- R _{thJA}	50	62.5	52	62.5		
	Steady State	' ¹thJA	90	110	90	110	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	32	40	32	40		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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SPECIFICATIONS $T_J = 25$ °	C, unless o	therwise noted						
Parameter Symbol Tes		Test Conditions		Min.	Тур.	Max.	Unit	
Static								
Gate Threshold Voltage	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	N-Ch	1.0			٧	
	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	P-Ch	- 1.0				
Cata Badul salvana		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	N-Ch			± 100	nA	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	P-Ch			± 100		
		V _{DS} = 24 V, V _{GS} = 0 V	N-Ch			1		
	1.	V _{DS} = - 24 V, V _{GS} = 0 V	P-Ch			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 24 V, V _{GS} = 0 V, T _J = 55 °C	N-Ch			5	μΑ	
		V _{DS} = - 24 V, V _{GS} = 0 V, T _J = 55 °C	P-Ch			- 5		
		$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	N-Ch	30			А	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	P-Ch	- 30				
		V _{GS} = 10 V, I _D = 5.9 A	N-Ch		0.032	0.036		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 4.9 A	P-Ch		0.043	0.053		
		V _{GS} = 4.5 V, I _D = 4.9 A	N-Ch		0.042	0.053	Ω	
		V _{GS} = - 4.5 V, I _D = - 3.7 A	P-Ch		0.075	0.090		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 5.9 A	N-Ch		15			
		V _{DS} = - 15 V, I _D = - 4.9 A	P-Ch		9		S	
Diode Forward Voltage ^a	V _{SD}	I _S = 1.7 A, V _{GS} = 0 V	N-Ch		0.80	1.2	V	
		I _S = - 1.7 A, V _{GS} = 0 V	P-Ch		- 0.80	- 1.2		
Dynamic ^b								
Total Gate Charge	Q_g	N Channel	N-Ch		13	20		
Total date onarge		N-Channel $V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5.9 \text{ A}$	P-Ch		15	25	nC	
Gate-Source Charge	Q _{gs}	105 - 10 1, 165 - 10 1, 16 - 0.0 M	N-Ch		2.3			
		P-Channel	P-Ch		4			
Gate-Drain Charge		$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -4.9 \text{ A}$	N-Ch P-Ch		2 2.0			
			N-Ch	0.5	2.0	2.2		
Gate Resistance	R_g		P-Ch	5		12.6	Ω	
Turn-On Delay Time Rise Time			N-Ch		6	12		
	t _{d(on)}	N-Channel	P-Ch		7	15	-	
	t _r	$V_{DD} = 15 \text{ V}, R_L = 15 \Omega$ $I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_q = 6 \Omega$	N-Ch		14	25		
	T 'r	ID = IA, $VGEN - IOV$, $IIg - OS2$	P-Ch		10	20		
Turn-Off Delay Time Fall Time	t _{d(off)}	P-Channel	N-Ch		30	60	ns	
	(- /	$V_{DD} = -15 \text{ V}, R_{L} = 15 \Omega$	P-Ch		40	80		
	t _f	$I_D \cong$ - 1 A, V_{GEN} = - 10 V, R_g = 6 Ω	N-Ch P-Ch		5 20	10 40		
		I _F = 1.7 A, dI/dt = 100 A/μs	N-Ch		30	60	-	
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = 1.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$ $I_F = -1.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$	P-Ch		30	60		
Tieverse riccovery fillic		i _F - · 1.7 A, αί/αι = 100 A/μS	P-UI		30	υσ		

Notes:

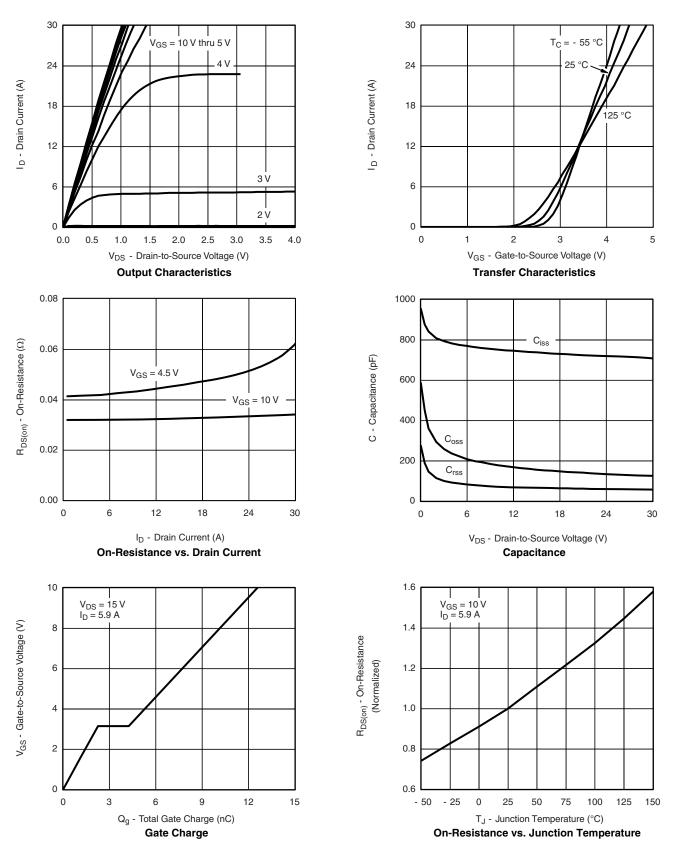
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.



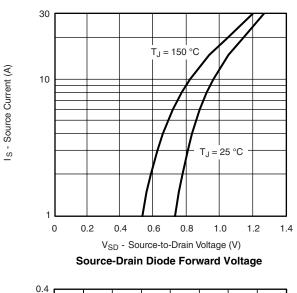
N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

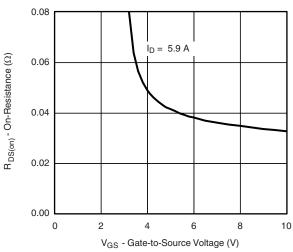


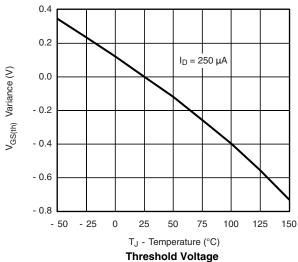
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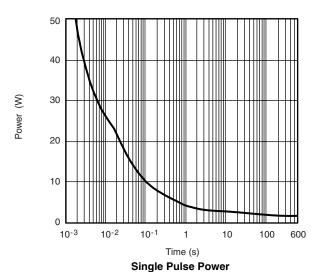
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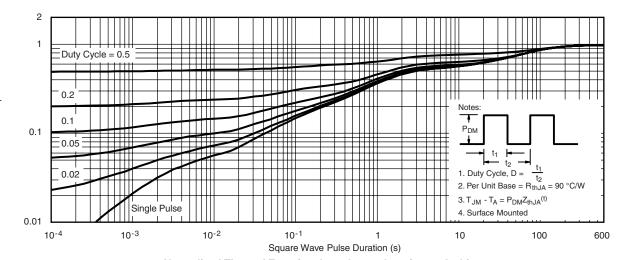




On-Resistance vs. Gate-to-Source Voltage



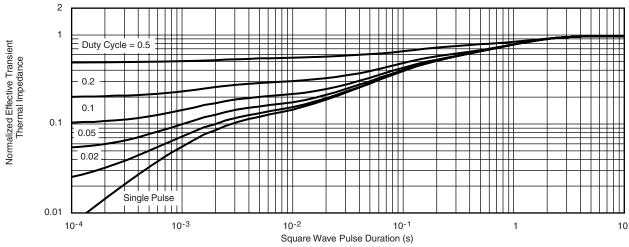
Normalized Effective Transient Thermal Impedance



Normalized Thermal Transient Impedance, Junction-to-Ambient

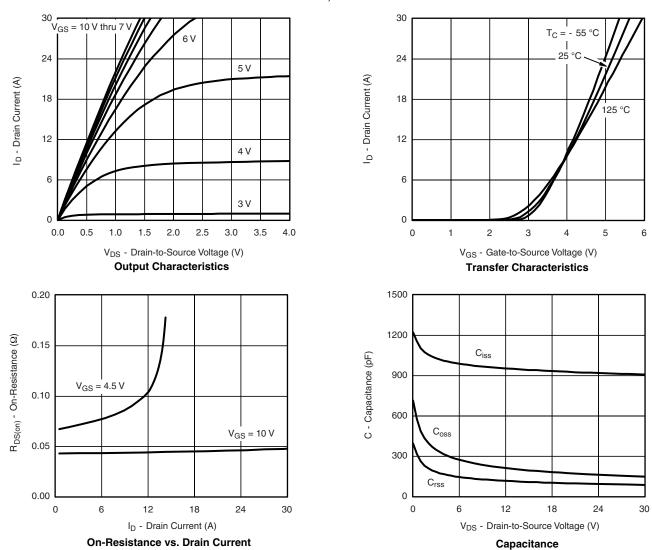


N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

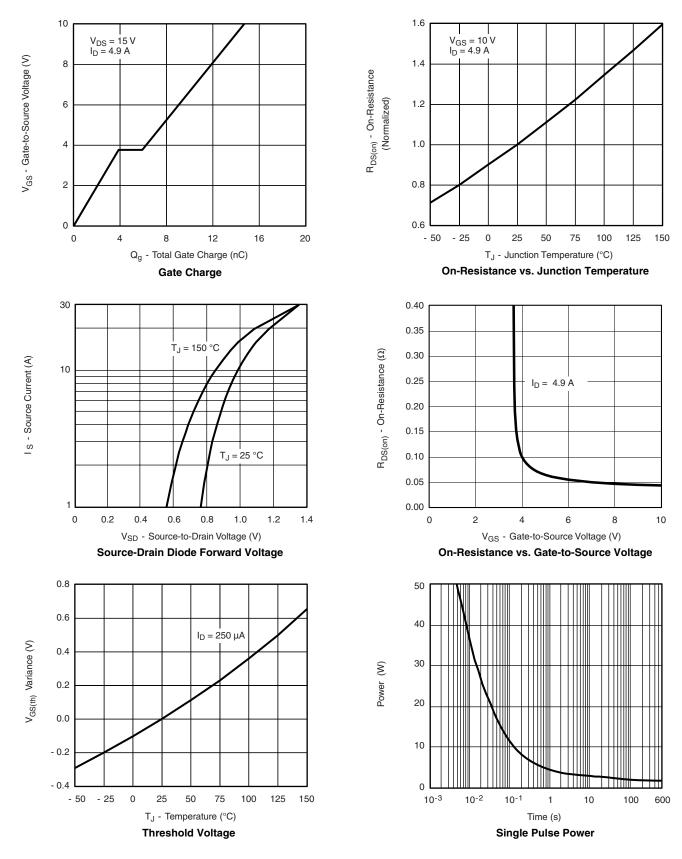


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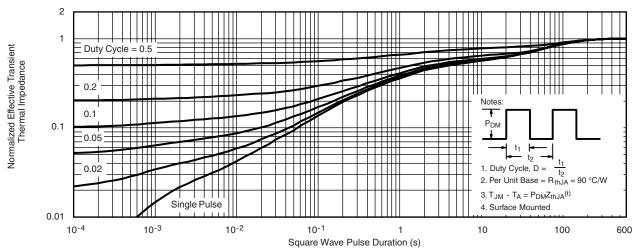
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P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

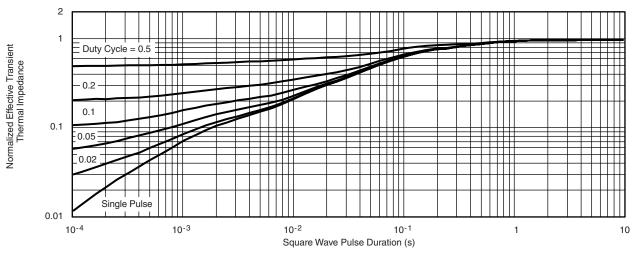




P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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